



## Description

The AQY2xxEH is solid state relays containing an AlGaAs infrared LEDs on the light emitting side (input side) optically coupled to a high voltage output detector circuit. The detector consists of a photovoltaic diode array and MOSFETs on the output side. The single channel configuration is equivalent to 1 form A EMR. It is packaged in a 4-pin package and in wide-lead spacing and SMD option.

## Features

- Normally open signal pole signal throw relay
- Low operating current
- 60 to 600V output withstand voltage
- Wide operating temperature range of -40°C to 85°C
- High input-output isolation voltage(Viso= 5,000Vrms)
- RoHS

## Applications

- Measurement equipment
- Exchange equipment
- FA/OA equipment
- Security
- Industrial controls

## Package Marking and Ordering Information

Product ID	Pack	Qty(PCS)	Packaging
AQY2xxEH	DIP-4	100	Tube
AQY2xxEH	SMD-4	4000	Reel

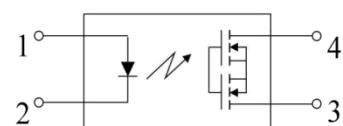
xx: From 12, 14, 16



**DIP-4**



**SMD-4**



Pin Configuration

1. AN
2. CA
3. D1
4. D2



## Maximum Ratings

Parameter		Symbol	Values		Unit	
Input	Forward Current	$I_F$	50		mA	
	Reverse Voltage	$V_R$	6		V	
	Power Dissipation	$P$	75		mw	
	Peak Forward Current (100 $\mu$ s pulse, 100Hz)	$I_{FP}$	1		A	
	Thermal Resistance Junction-Ambient	$R_{thJ-A}$	325		°C/W	
	Thermal Resistance Junction-Case	$R_{thJ-C}$	200		°C/W	
Output	Break Down Voltage	$V_L$	AQY212EH	60	V	
			AQY214EH	400		
			AQY216EH	600		
	Continuous Load Current	$I_L$	AQY212EH	550	mA	
			AQY214EH	120		
			AQY216EH	50		
	Pulse Load Current <sup>(1)</sup>	$I_{LPeak}$	AQY212EH	1.2	A	
			AQY214EH	0.3		
			AQY216EH	0.15		
Power Dissipation		$P_{out}$	500		mw	
Operating temperature range		$T_{op}$	-40 ~ 85		°C	
Storage temperature range		$T_{stg}$	-40 ~ 125		°C	
Total Power consumption		$P(W)$	550		mw	
Isolation Voltage <sup>(2)</sup>		$V_{ISO}$	5000		Vrms	
Soldering Temperature <sup>(3)</sup>		$T_{SOL}$	260		°C	

### Notes:

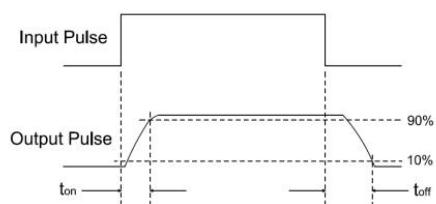
- (1). A connection: 100ms (1 shot),  $V_L$  = DC
- (2)AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 3 are shorted together, and pins 4, 6 are shorted together.
- (3).For 10 seconds



### Electronic Optical Characteristics (TA = 25°C)

Parameter		Symbol	Min.	Typ.	Max.	Unit	Condition
Input	Forward Voltage	V <sub>F</sub>	-	1.2	1.5	V	I <sub>F</sub> =10mA
	Reverse Current	I <sub>R</sub>	-	-	1	μA	V <sub>R</sub> =5V
Output	Off State leakage Current	I <sub>leak</sub>	-	-	1	μA	I <sub>F</sub> =0mA, V <sub>L</sub> =Max
	On Resistance	R <sub>d(ON)</sub>	-	0.7	2.5	Ω	I <sub>F</sub> =10mA, I <sub>L</sub> = Max. t = 1s
			-	20	30		
			-	40	70		
	Output Capacitance	C <sub>out</sub>	-	80	-	pF	VL = 0V, f = 1MHz
			-	45	-		
			-	30	-		
Transfer Characteristics	LED turn on Current	I <sub>F(on)</sub>		2.5	5	mA	I <sub>L</sub> = Max.
	LED turn off current	I <sub>F(off)</sub>	0.4	2.5	-	mA	I <sub>L</sub> = Max.
Turn On Time	AQY212EH	T <sub>ON</sub>	-	1.4	3	ms	I <sub>F</sub> = 10 mA, I <sub>L</sub> = Max. R <sub>L</sub> = 200 Ω,
	AQY214EH		-	0.4	3		
	AQY216EH		-	1.4	3		
Turn Off Time	AQY212EH	T <sub>OFF</sub>	-	0.05	0.5		
	AQY214EH		-	0.05	0.5		
	AQY216EH		-	0.05	0.5		

Turn on/Turn off Time





## Characteristics Curves

Fig.1 LED Dropout Voltage vs. Ambient Temperature

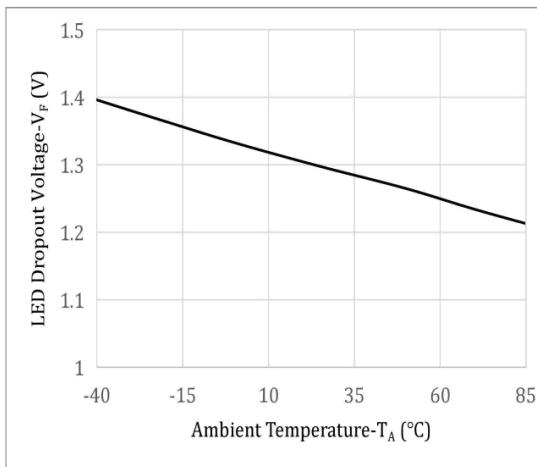


Fig.2 Output Current vs. Output Voltage

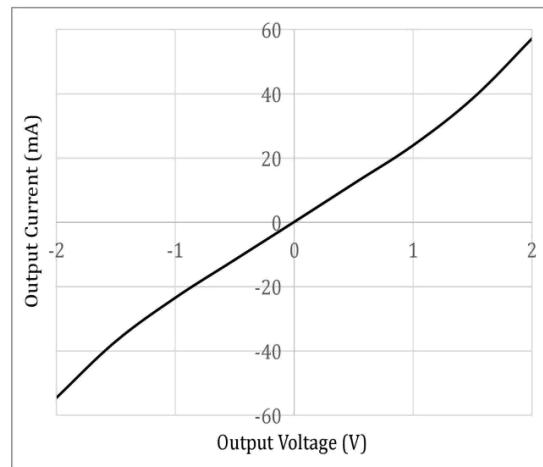


Fig.3 On Resistance vs. Ambient

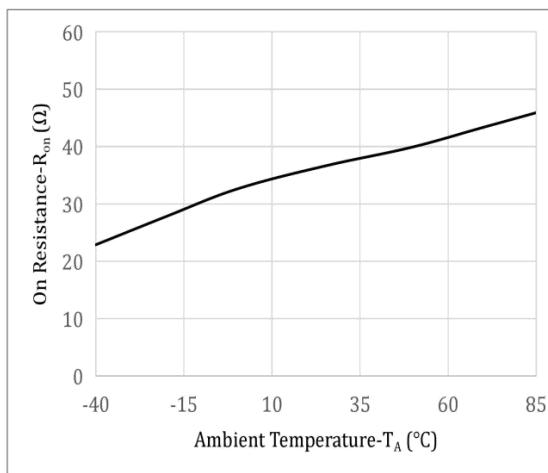


Fig.4 Load Current vs. Ambient Temperature

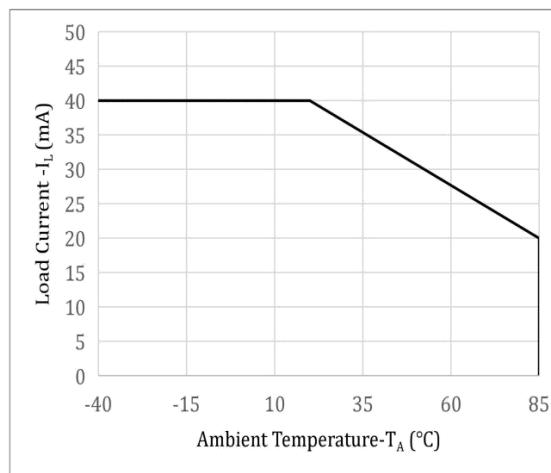


Fig.5 LED Operate Current vs. Ambient Temperature

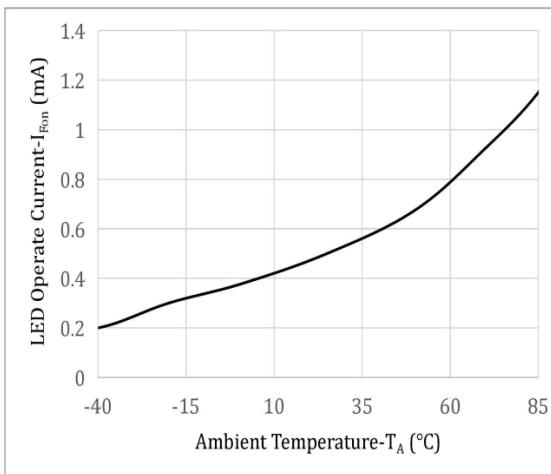


Fig.6 LED Turn Off Current vs. Ambient

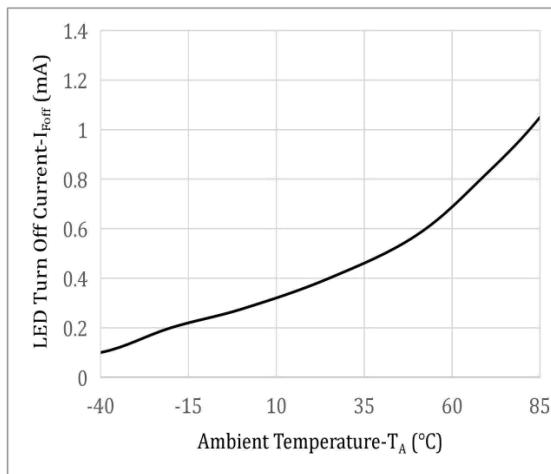




Fig.7 Turn On Time vs. Ambient Temperature

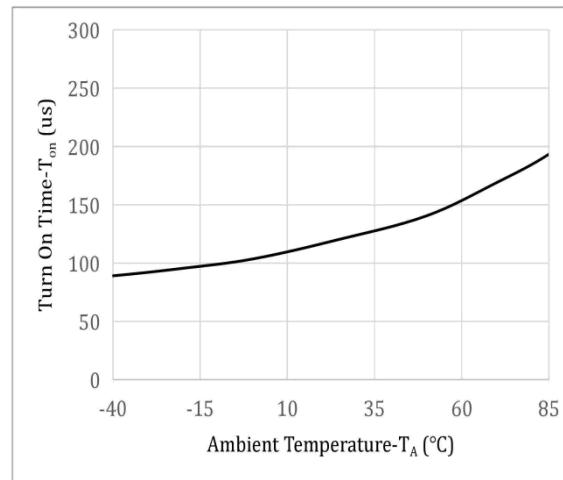


Fig.8 Turn Off Time vs. Ambient Temperature

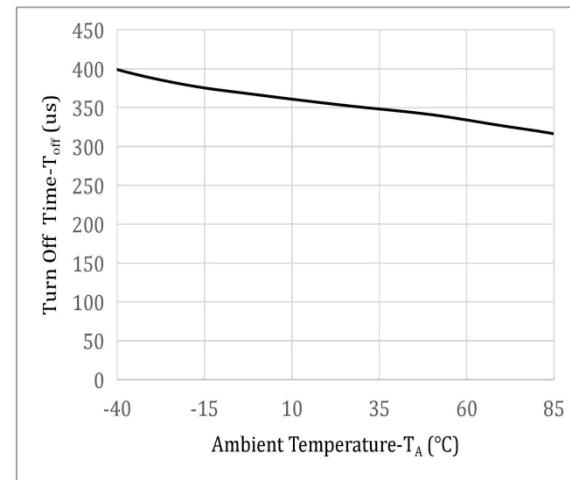


Fig.9 Turn On Time vs. LED Forward Current

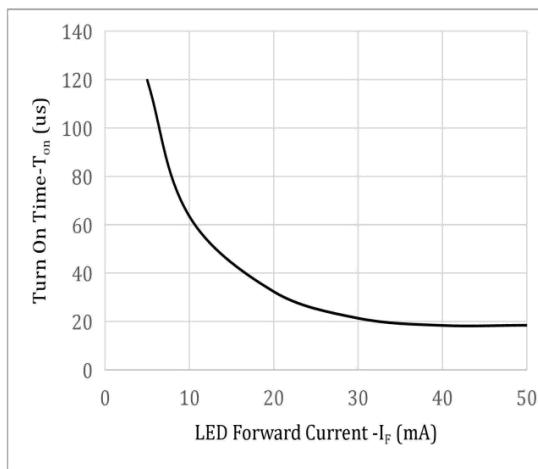


Fig.10 Turn Off Time vs. LED Forward

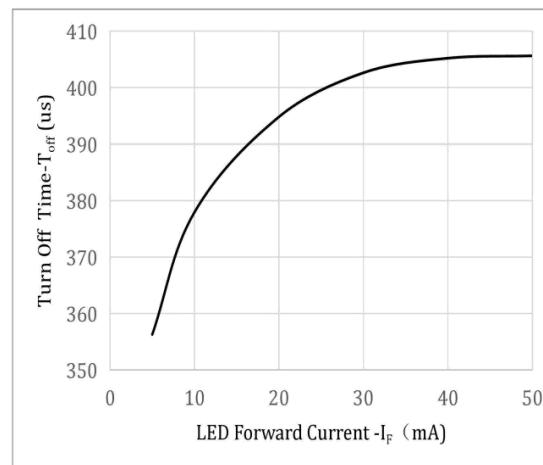
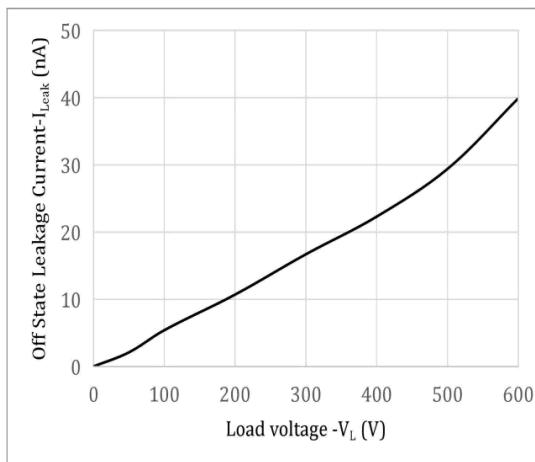


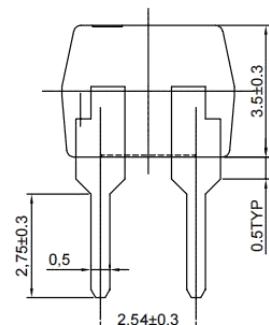
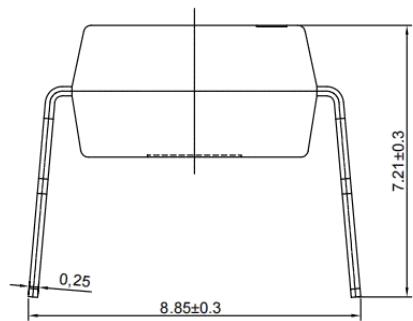
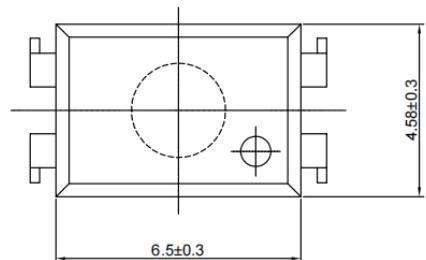
Fig.11 Off State Leakage Current vs Load Voltage





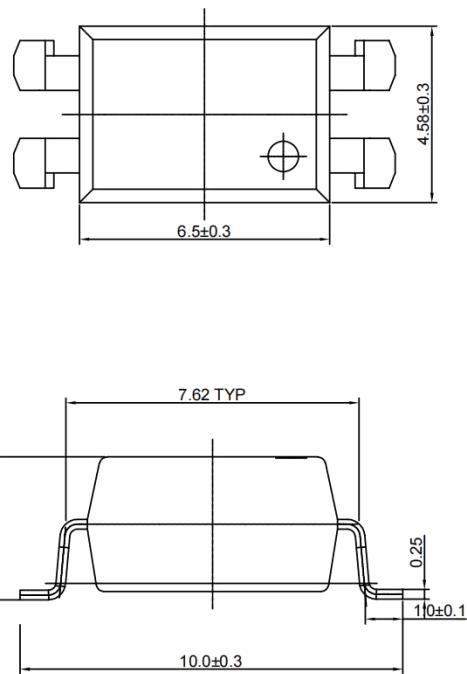
## Outline Dimension

DIP-4 Type:





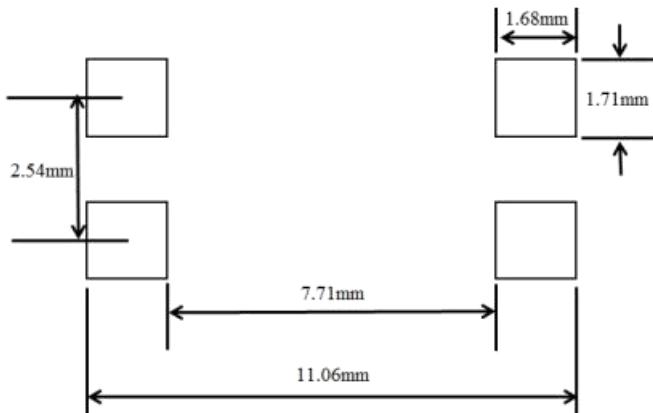
SMD-4 Type:



Unit: mm

Tolerance: ±0.1mm

**Recommended solder pad Design**



Unit: mm

Tolerance: ±0.1mm

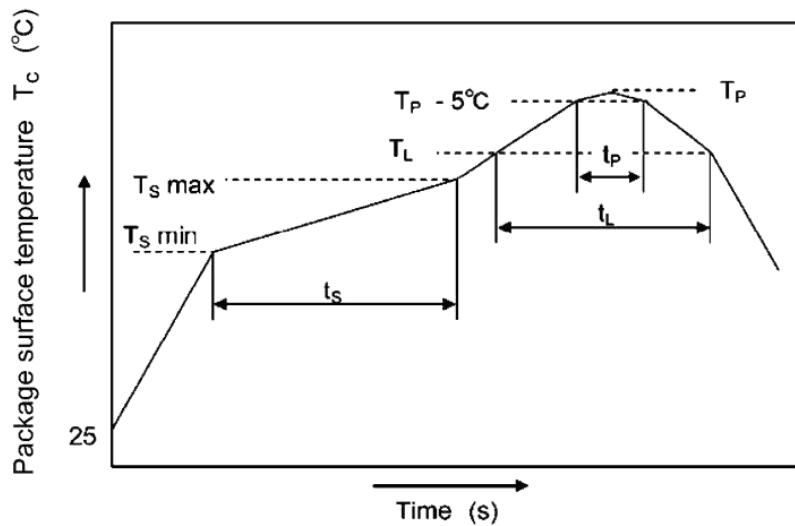


## Temperature Profile Of Soldering

### 1. IR Reflow soldering

(JEDEC-STD-020D compliant)

Profile item	Conditon
Preheat	
-Temperature Min (TSmin)	150°C
-Temperature Max (TSmax)	200°C
-Time (min to max) (ts)	90±30 sec
Soldering zone	
-Temperature (TL)	217°C
-Time (t <sub>L</sub> )	60-150 sec
Peak Temperature (TP)	260°C
-Time (TP-5°C to TP) (ts)	30 sec
Ramp-up rate	3°C / sec max
Ramp-down rate	3~6°C/ sec



#### Notes:

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



## 2. Wave soldering (JEDEC22A111 compliant)

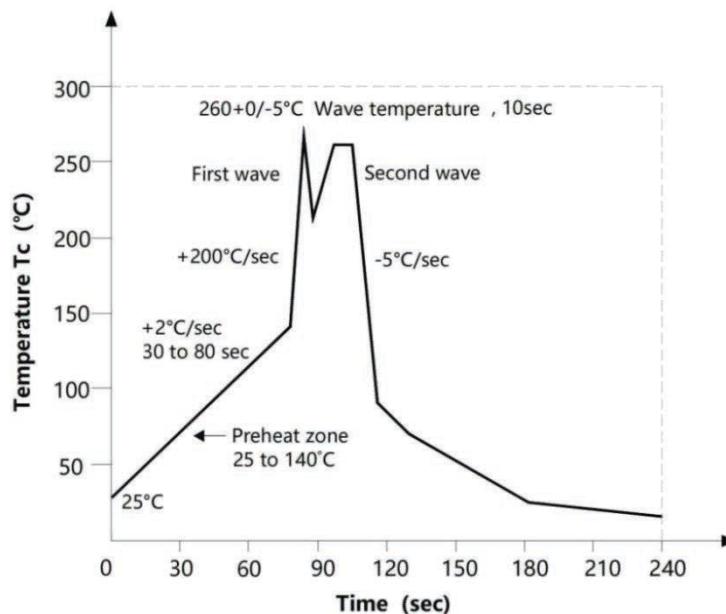
One time soldering is recommended within the condition.

Temperature: 260+0/-5°C.

Time: 10 sec.

Preheat temperature: 25 to 140°C.

Preheat time: 30 to 80 sec.



## 3. Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5°C

Time: 3 sec max.



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